

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In the application of:

Takuo WATANABE *et al.*

Serial No.: 10/591,580

Filing Date: September 5, 2006

For: HEAT-RESISTANT RESIN LAMINATED
FILM, MULTILAYER FILM WITH METAL
LAYER INCLUDING SAME AND
SEMICONDUCTOR DEVICE

Examiner: Monique R. Jackson

Art Unit: 1794

Confirmation No.: 6245

AMENDMENT UNDER 37 CFR 1.111

MS Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

In response to the Action dated January 9, 2008, please amend this application as follows.

The Listing of the Claims begins on page 2.

Remarks begin on page 6.